## **Permabond**<sup>®</sup> Adhesives for Electronics

Permabond offers a wide range of different adhesive technologies for bonding electronic components. Whether you require a rapid cure in seconds or several hours to assemble parts, Permabond can help you find a bonding solution.

### Permabond<sup>®</sup> Adhesive Typical Applications

Permabond offers a wide range of different adhesive technologies for bonding electronic components. Whether you require a rapid cure in seconds or several hours to assemble parts, Permabond can help you find a bonding solution.

Typical applications where Permabond adhesives can be used includes:

- Wire tacking
- Bonding heat sinks
   Bonding of surface mount devices to
- Bonding of surface mount devices to PCBs
   Potting and encapsulation of electronic components
- Potting and encapsulation of electron
   Component rigidising
- Component rigidising
- Conformal coating to protect electronic components / PCBs
- Applications within batteries and battery packs
- Strain protection for leads / plugs
- Torroid bonding
- Coil winding
- Magnet bonding & electric motor applications
- Bonding electronics housings and enclosures
- Bonding touch screens and keypads
- Sensor bonding / potting
- Electrical transformers
- ...and many more!



Ideal for bonding: ABS Acetal Acrylic Aluminium Carbon Fibre Copper Ferrite FRP/GRP/Gelcoat Glass Laminate Magnet PCB Phenolic Polycarbonate Polyethylene\* Polypropylene\* **PVC** Silicon Steel Tungsten Zinc

+Many more materials \*Special grades only on untreated



## Permabond Adhesives for Electronics

Here is a small selection of our most popular adhesive grades suitable for use in a range of electronic component bonding applications. If you can't see exactly what you require, please contact our technical advisors with information about your application and your particular requirements and we will make a recommendation. The Permabond team provides support through the design phase, sample trials and production line integration. Whether you require technical support, custom formulations or small batch production, please contact us.

### Electronic Components Bonding Product Data

| Technical<br>Information             | 820  | 920  | 947   | CSA-NF  | ES566   | ES578  |
|--------------------------------------|--|--|---|---|---|--|
| Typical application                  | SMD Bonding, wire tacking  | SMD Bonding, wire<br>tacking, torroid<br>bonding   | Wire tacking, bonding<br>housings   | Wire tacking, bonding housings  | Bonding components, component rigidising  | Bonding heat sinks   |
| Features                             | Single part, moisture<br>cure cyanoacrylate<br>adhesive with high<br>temperature<br>resistance | Single part, moisture<br>cure cyanoacrylate<br>adhesive with high<br>temperature<br>resistance | Single part, moisture<br>cure cyanoacrylate<br>adhesive. Low odour<br>/ non-bloom | Cyanoacrylate activa-<br>tor. Non-flammable,<br>low residue. Ideal<br>for speeding up cure<br>and for curing excess<br>adhesive | Heat cure single part<br>epoxy which cures at<br>temperatures <100°C<br>to help protect<br>temperature-sensitive<br>electronics | Heat cure single part<br>epoxy with good<br>thermal conductivity<br>properties |
| Colour                               | Clear, colourless  | Clear, colourless  | Clear, colourless   | Clear / colourless  | Grey  |  |
| Viscosity (mPa.s = cP)               | 90-110   | 70-90  | 900-1,500   | 1   | Thixotropic paste   | Thixotropic paste  |
| Maximum gap fill (mm) in             | (0.15)<br>0.006  | (0.15)<br>0.006  | (0.25)<br>0.01  | -   | (2.0)<br>0.08   | (5.0)<br>0.2   |
| Handling time (steel)                | 10-15 sec.   | 15-20 sec.   | 10-15 sec.  | -   | 90°C (175°F): 75 min.<br>100°C (210°F): 40 min.   | 130° C (266°F): 75 min.<br>150°C (300°F): 60 min.<br>170°C (338°F): 25 min.    |
| Full strength<br>(cured at 23°C)     | 24 hours   | 24 hours   | 24 hours  | -   | 120°C (250°F): 25 min.<br>150°C (300°F): 10 min.  |  |
| Shear strength Steel<br>(MPa)<br>psi | (19-23)<br>2800-3300   | (19-23)<br>2800-3300   | (16-20)<br>2300-2900  | -   | 5-10 (cured at 90°C)<br>18-22 (cured at<br>>100°C   | 750-1500 (cured at<br>175°F) 2600-3200<br>(cured at >210°F)                    |
| Service temperature range<br>(°C)°F  | (-55 to +200)<br>-65 to +390   | (-55 to +250)<br>-65 to +482*  | (-55 to +80)<br>-65 to +180   | -   | (-40 to +180)<br>-40 to +356  | (-40 to +180)<br>-40 to +356   |
| Dielectric strength<br>kV/mm         | 25   | -  | 25  |   | -   | 40-45  |
| Thermal conductivity<br>W/(m.K)      | 0.1  | 0.1  | 0.1   | -   | -   | 1.3  |
| Availability                         | Worldwide  | Worldwide  | Worldwide   | Worldwide   | Worldwide   | Worldwide  |

For full, up-to-date technical information, please refer to the TDS (Technical Data Sheet). \* Product cured at 150°C for 2 hours.

Application: Coil Winding
Loudspeaker coil winding runs through
epoxy "bath" and is subsequently coiled
prior to the epoxy setting.
Excellent optical clarity
Low, penetrative viscosity for good
coverage
Adhesive used: Permaband ET530



#### Application: Bonding torroids

Adhesive is applied for bonding copper wire to the ferrite core of a torroid.

Improved durability

Improved resistance against high levels of vibration & temperature

#### Adhesive used: Permabond 920











| ET530  | MT382  | MT3826   | PT326  | TA4392   | TA459  | UV681   | UV683   |
|--|--|--|--|--|--|---|---|
| Potting and coating, coating copper wire coils                 | Potting and encapsulation  | Bonding heat sinks   | Potting, bonding<br>components   | Magnet bonding,<br>bonding heat sinks  | Magnet bonding   | Tack-free clear<br>coating - ideal for<br>conformal coating                                       | Tack-free doming viscosity                        |
| Low viscosity<br>2-part epoxy.<br>Cures at room<br>temperature | Low viscosity, self<br>levelling, soft,<br>slightly flexible<br>modified 2-part<br>epoxy | Modified flexible<br>2-part epoxy with<br>good thermal<br>conductivity<br>properties | 2-Part polyure-<br>thane adhesive<br>with high peel and<br>impact strength | Structural acrylic<br>resin + initiator<br>41 Rapid cure<br>and good thermal<br>conductivity | Structural acrylic<br>with non-acidic<br>formulation for<br>sensitive electron-<br>ics. Use with initia-<br>tor 41 or 43 | Single-part low-<br>viscosity UV-curing<br>resin  | Single-part, high<br>viscosity UV curing<br>resin |
| Clear, colourless  | Charcoal black   | Cream  | Grey   | White  | Blue   | Clear, colourless   | Clear, colourless                                 |
| 400-800  | Mixed:<br>13,000-30,000  | Thixotropic paste  | Mixed:<br>3500-7000  | 200,000  | 20rpm: 20,000<br>2.5rpm: 80,000  | 80-120  | 1000-1600   |
| -  | (0.5)<br>0.02  | (5.0)<br>0.2   | (5.0)<br>0.2   | (0.5)<br>0.02  | (0.5)<br>0.02  | -   | -   |
| 8-12 hrs   | 105-120 min.   | 10-40 min.   | 60-90 min.   | 10-30 sec.   | 40-75 sec.   | Normally seconds - depends on UV lamp<br>intensity and output spectra, distance<br>from substrate |   |
| 72 hrs   | 72 hrs   | >72 hrs  | 4-5 days   | 24 hrs   | 24 hrs   |   |   |
| (8-12)<br>1200-1700  | (4-7)<br>600-1000  | Zinc (3-5)<br>400-600  | (12-20)<br>1700-2900   | (16-20)<br>2300-2900   | (20-25)<br>2900-3600   | -   | -   |
| (-40 to +100)<br>-40 to +215                                   | (-40 to +120)<br>-40 to +250   | (-40 to +120)<br>-40 to +250   | (-40 to +120)<br>-40 to +250   | (-55 to +165)<br>-65 to +329   | (-55 to +165)<br>-65 to +329   | (-55 to +120)<br>-65 to +250  | (-55 to +120)<br>-65 to +250                      |
| 450 V/mil  | -  | -  | -  | 25-30  | 30-50  | -   |   |
| 0.2  | -  | 1.4-1.6  | -  | 1.111  | 0.1  | -   | -   |
| Worldwide  | Worldwide  | Worldwide  | Worldwide  | Worldwide  | Worldwide  | Worldwide   | Worldwide   |

#### Application: Bonding SMDs



Soldering and fixing components to either side of a PCB can be very difficult - when you try to solder one side, the component drops off the other. Permabond adhesive can be used to secure components which may later need to go through a solder reflow process.

- High wet strength
- Good thermal conductivity
- Good electrical resistance
- Adhesive used: Permabond ES578

#### Application: Wire Tacking

Permabond cyanoacrylates can be used for the instant tacking of wires inside electronic devices. Tacking wires keeps circuit boards neat and tidy and easier to handle in later stages of the assembly process. Excess adhesive can be cured instantly with Permabond CSA-NF (which minimises visible residue).

> Wire on power tool PCB tacked in place to help ease of component assembly





# **Permabond**<sup>®</sup> Adhesives for Electronics

#### Adhesives for • Design • Manufacturing • Assembly • Maintenance • Repair & Overhaul

Permabond's history of developing and manufacturing engineering adhesives spans four decades and three continents. Today, Permabond Engineering Adhesives Ltd (Europe & Asia) and Permabond LLC (Americas) provide technological solutions to engineers all over the world, with offices and facilities in America, Asia and Europe. ISO 9001:2008



- **Technical** Our chemists and technicians are available to provide application assistance, custom formulation, inhouse prototype testing, joint product development programs and much more.
- **Training** Permabond's knowledgeable sales group will provide your staff with the information they need to maximize the efficiencies, cost savings, and safety benefits Permabond products generate.
- Sales From preliminary project appraisals and product needs assessments through to process reliability analysis, Permabond's knowledgeable sales group will support you from product concept through to production.

**Distributor Stamp** 

This brochure contains information on our most popular products, if you don't see exactly what you need, or would like assistance in selecting the best product for your application, please contact us:

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| their accuracy can be given or accepted, however, and no statement herein is to be treated as a representation or warranty. In every case we urge and recommend        |
| that purchasers, before using any product, make their own tests to determine, to their own satisfaction, its suitability for their particular purposes under their own |
| operating conditions. Always refer to current product technical datasheet for most recent and accurate technical information.  |
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